

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2884691

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the FIRST INVENTOR'S EXECUTION DATE previously recorded on Reel 032366 Frame 0284. Assignor(s) hereby confirms the THE INVENTOR EXECUTED THE ASSIGNMENT ON 2/11/2014.

CONVEYING PARTY DATA

Name	Execution Date
DANIEL CALAFUT	02/11/2014
MADHUR BOBDE	01/31/2014
YEEHENG LEE	02/03/2014
HONG CHANG	01/31/2014

RECEIVING PARTY DATA

Name:	ALPHA AND OMEGA SEMICONDUCTOR INCORPORATED
Street Address:	475 OAKMEAD PKWY.
City:	SUNNYVALE
State/Country:	CALIFORNIA
Postal Code:	94085

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14138103

CORRESPONDENCE DATA

Fax Number: (408)973-2595
Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 408-973-2585
Email: vpula@ip-patent.com
Correspondent Name: VAN PELT, YI & JAMES LLP
Address Line 1: 10050 N. FOOTHILL BLVD.
Address Line 2: SUITE 200
Address Line 4: CUPERTINO, CALIFORNIA 95014

ATTORNEY DOCKET NUMBER:	ALPHP036
NAME OF SUBMITTER:	CARMEN C. COOK
SIGNATURE:	/Carmen C Cook/
DATE SIGNED:	06/04/2014

Total Attachments: 3

PATENT

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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT2756058

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>DANIEL CALAFUT</td> <td>02/01/2014</td> </tr> <tr> <td>MADHUR BOBDE</td> <td>01/31/2014</td> </tr> <tr> <td>YEEHENG LEE</td> <td>02/03/2014</td> </tr> <tr> <td>HONG CHANG</td> <td>01/31/2014</td> </tr> </tbody> </table>		Name	Execution Date	DANIEL CALAFUT	02/01/2014	MADHUR BOBDE	01/31/2014	YEEHENG LEE	02/03/2014	HONG CHANG	01/31/2014
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Address Line 4:	CUPERTINO, CALIFORNIA 95014										
ATTORNEY DOCKET NUMBER:	ALPHP036										
NAME OF SUBMITTER:	CARMEN C. COOK										
Signature:	/Carmen C Cook/										

ASSIGNMENT OF PATENT APPLICATION

Whereas I/we the undersigned inventor(s) have invented certain new and useful improvements as set forth in the patent application entitled:

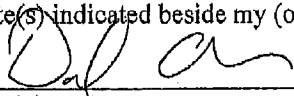
DUAL OXIDE TRENCH GATE POWER MOSFET USING OXIDE FILLED TRENCH

for which I (we) have executed an application for a United States Letters Patent which was filed in the U.S. Patent and Trademark Office on December 22, 2013, and which bears the Application No. 14/138,103 (the "Application");

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we the undersigned inventor(s) hereby:

- 1) Sell, assign, and transfer to Alpha and Omega Semiconductor Incorporated, a California corporation having a place of business at 475 Oakmead Pkwy., Sunnyvale, CA 94085 (hereinafter referred to as "ASSIGNEE"), the entire right title and interest in any and all improvements and inventions disclosed in, application(s) (including foreign applications) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed in the above referenced application and/or in any provisional application to which the above referenced application claims priority.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division(s), continuation(s), substitutes(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I/we have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the date(s) indicated beside my (our) signature(s).

- | | | |
|----|---|------------------------|
| 1) | Signature: <u></u> | Date: <u>2/11/2014</u> |
| | Typed Name: Daniel Calafut | |
| 2) | Signature: _____ | Date: _____ |
| | Typed Name: Madhur Bobde | |
| 3) | Signature: _____ | Date: _____ |
| | Typed Name: Yeeheng Lee | |
| 4) | Signature: _____ | Date: _____ |
| | Typed Name: Hong Chang | |

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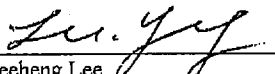
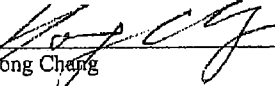
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| 1) | Signature: _____
Typed Name: Daniel Calafut | Date: _____ |
| 2) | Signature: 
Typed Name: Madhur Bobde | Date: 1/31/2014 |
| 3) | Signature: 
Typed Name: Yeeheng Lee | Date: 2/3/2014 |
| 4) | Signature: 
Typed Name: Hong Chang | Date: 1/31/2014 |